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(54) Title: CONDUCTIVE, MULTILAYER STACKS FOR USE IN SILICON SOLAR CELLS AND PROCESSES FOR MAKING AND USING THE SAME INCLUDING LASER-BASED PROCESSES

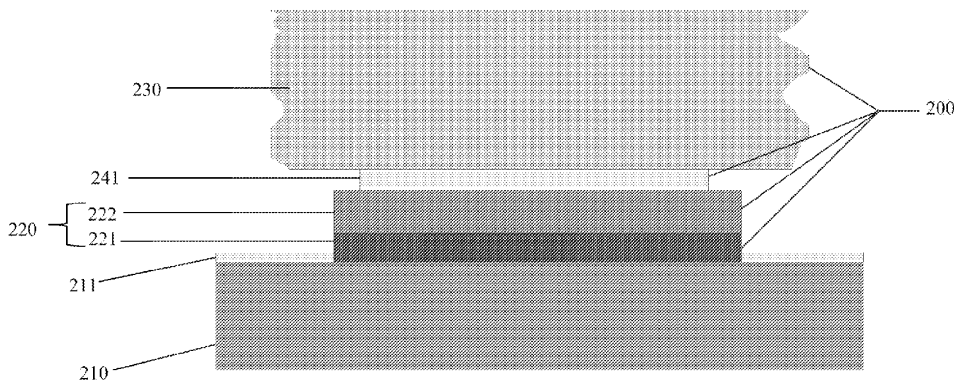


FIG. 2

(57) Abstract: A conductive multilayer stack or a conductive multilayer line useful as a metallization layer in photovoltaics as well as other devices; solar cells having a conductive multilayer stack or line; solar modules having such cells; and methods of forming a conductive multilayer stack or line. The conductive multilayer stack or line having a metal layer including copper (Cu) or coated aluminum; a silver contact layer; and a solderable layer between, and contacting, the metal layer and the silver contact layer.

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